Schottky Barrier Rectifiers, Surface Mount, 3 A, 40 V-100 V

Features

- Low Power Loss, High Efficiency
- Guard Ring for Overvoltage Protection
- High Surge Current Capability
- UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- This Device is Pb-Free and RoHS Compliant

ABSOLUTE MAXIMUM RATINGS

(Values are at $T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	SS34FA	SS36FA	S310FA	Unit	
V _{RRM}	RM Repetitive Peak Reverse Voltage		60	100	V	
V _{RMS}	RMS Reverse Voltage	28	42	70	V	
V _R	DC Blocking Voltage	40	60	100	V	
I _{F(AV)}	Average Forward Rectified Current		3		A	
I _{FSM}	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load		80		A	
TJ	Operating Junction Temperature Range	-55 to -55 to +150 +125		0 +150	°C	
T _{STG}	Storage Temperature Range	e -55 to +150		0	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

(Values are at $T_A = 25^{\circ}C$ unless otherwise noted) (Note 1)

Symbol	Parameter	Value	Unit
ΨJL	Thermal Characteristics, Junction-to-Lead	16	°C/W
$R_{\theta JA}$	$R_{\theta JA}$ Thermal Resistance, Junction-to-Ambient		°C/W

1. Per JESD51–3 Recommended Thermal Test Board. Device mounted on FR–4 PCB, board size = 76.2 mm \times 114.3 mm.



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SOD-123FL CASE 425AB



MARKING DIAGRAM



- &Y = Binary Calendar Year Coding Scheme
- &Z = Assembly Plant Code
 - = Specific Device Code
 - (34L, 36L or 30L)

&G = Single Digit Weekly Datecode

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS (Values are at $T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Conditions	SS34FA	SS36FA	S310FA	Unit
V _F	Maximum Instantaneous Forward Voltage (Note 2)	I _F = 3 A	0.50	0.75	0.85	V
I _R	Maximum Reverse Current at	$T_J = 25^{\circ}C$	0.5		0.1	mA
		T _J = 125°C	60	10	5	
CJ	Typical Junction Capacitance	V _R = 4 V, f = 1 MHz	152	117	78	pF
T _{rr}	Typical Reverse Recovery Time	I _F = 0.5 A, I _R = 1 A, I _{RR} = 0.25 A	12	11	8	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse test with PW = $300 \ \mu s$, 1% duty cycle.

ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping [†]
SS34FA, NRVBSS34FA*	34L	SOD-123FL (Pb-Free)	3,000 / Tape & Reel
SS36FA, NRVBSS36FA*	36L	SOD-123FL (Pb-Free)	3,000 / Tape & Reel
S310FA, NRVBS310FA*	30L	SOD-123FL (Pb-Free)	3,000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable

TYPICAL PERFORMANCE CHARACTERISTICS



Figure 1. Forward Current Derating Curve



Figure 2. Maximum Non-Repetitive Forward Surge Current



Figure 3. Typical Forward Characteristics



Figure 5. Typical Forward Characteristics



Figure 4. Typical Forward Characteristics



Figure 6. Typical Reverse Characteristics

TYPICAL CHARACTERISTICS (Continued)



Figure 7. Typical Reverse Characteristics



Figure 8. Typical Reverse Characteristics



Figure 9. Typical Junction Capacitance

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS









FRONT VIEW



BOTTOM VIEW

SOD-123FA CASE 425AB **ISSUE A**

DATE 11 AUG 2022

NDTES:

- NO INDUSTRY STANDARD APPLIES TO 1. THIS PACKAGE.
- 2.
- ALL DIMENSIONS ARE IN MILLIMETERS. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND THE BAR PROTRUSIONS. З.

DIM	MILLIMETERS			
INI	MIN.	NDM.	MAX.	
A	1.23	1.33	1.43	
b	0.80	1.00	1.20	
C	0.16	0.23	0.30	
D	2.70	2.80	2.90	
D1	3.40	3.60	3.80	
E	1.70	1.80	1.90	
He	2.45		2.60	
L	0.35	0.60	0.85	



MOUNTING FOOTPRINT*

* For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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